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Intel - 5SGXEA4K3F40C2LN Datasheet



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Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

| Details | |
|--------------------------------|---|
| Product Status | Obsolete |
| Number of LABs/CLBs | 158500 |
| Number of Logic Elements/Cells | 420000 |
| Total RAM Bits | 37888000 |
| Number of I/O | 696 |
| Number of Gates | - |
| Voltage - Supply | 0.82V ~ 0.88V |
| Mounting Type | Surface Mount |
| Operating Temperature | 0°C ~ 85°C (TJ) |
| Package / Case | 1517-BBGA, FCBGA |
| Supplier Device Package | 1517-FBGA (40x40) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/5sgxea4k3f40c2ln |
| | |

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

| | | (| -, | | | | | |
|----------------------------|----|---------|-----|----------|----------|---------|--------------|-----|
| Transceiver Speed Grade | | | | Core Spe | ed Grade | | | |
| | C1 | C2, C2L | C3 | C4 | 12, 12L | 13, 13L | I 3YY | 14 |
| 3 | | Yes | Yes | Yes | | Yes | Yes (4) | Yes |
| GX channel—8.5 Gbps | | 165 | 165 | 165 | | 163 | 163 17 | 165 |

Table 1. Stratix V GX and GS Commercial and Industrial Speed Grade Offering ^{(1), (2), (3)} (Part 2 of 2)

Notes to Table 1:

(1) C = Commercial temperature grade; I = Industrial temperature grade.

(2) Lower number refers to faster speed grade.

(3) C2L, I2L, and I3L speed grades are for low-power devices.

(4) I3YY speed grades can achieve up to 10.3125 Gbps.

Table 2 lists the industrial and commercial speed grades for the Stratix V GT devices. **Table 2. Stratix V GT Commercial and Industrial Speed Grade Offering** ⁽¹⁾, ⁽²⁾

| Transaction Oracle Oracle | Core Speed Grade | | | | | | |
|--|------------------|-----|-----|-----|--|--|--|
| Transceiver Speed Grade | C1 | C2 | 12 | 13 | | | |
| 2 GX channel—12.5 Gbps GT channel—28.05 Gbps | Yes | Yes | _ | _ | | | |
| 3 GX channel—12.5 Gbps GT channel—25.78 Gbps | Yes | Yes | Yes | Yes | | | |

Notes to Table 2:

(1) C = Commercial temperature grade; I = Industrial temperature grade.

(2) Lower number refers to faster speed grade.

Absolute Maximum Ratings

Absolute maximum ratings define the maximum operating conditions for Stratix V devices. The values are based on experiments conducted with the devices and theoretical modeling of breakdown and damage mechanisms. The functional operation of the device is not implied for these conditions.



Conditions other than those listed in Table 3 may cause permanent damage to the device. Additionally, device operation at the absolute maximum ratings for extended periods of time may have adverse effects on the device.

| Table 3. | Absolute | Maximum | Ratings | for Stratix \ | / Devices | (Part 1 of 2) |
|----------|----------|---------|----------------|---------------|-----------|---------------|
|----------|----------|---------|----------------|---------------|-----------|---------------|

| Symbol | Description | Minimum | Maximum | Unit |
|---------------------|--|---------|---------|------|
| V _{CC} | Power supply for core voltage and periphery circuitry | -0.5 | 1.35 | V |
| V _{CCPT} | Power supply for programmable power technology | -0.5 | 1.8 | V |
| V _{CCPGM} | Power supply for configuration pins | -0.5 | 3.9 | V |
| V _{CC_AUX} | Auxiliary supply for the programmable power technology | -0.5 | 3.4 | V |
| V _{CCBAT} | Battery back-up power supply for design security volatile key register | -0.5 | 3.9 | V |
| V _{CCPD} | I/O pre-driver power supply | -0.5 | 3.9 | V |
| V _{CCIO} | I/O power supply | -0.5 | 3.9 | V |

This section lists the functional operating limits for the AC and DC parameters for Stratix V devices. Table 6 lists the steady-state voltage and current values expected from Stratix V devices. Power supply ramps must all be strictly monotonic, without plateaus.

Table 6. Recommended Operating Conditions for Stratix V Devices (Part 1 of 2)

| Symbol | Description | Condition | Min ⁽⁴⁾ | Тур | Max ⁽⁴⁾ | Unit |
|---|---|------------|--------------------|------|--------------------|------|
| | Core voltage and periphery circuitry power supply (C1, C2, I2, and I3YY speed grades) | _ | 0.87 | 0.9 | 0.93 | V |
| V _{CC} Core voltage and periphery circuitry power supply (C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) ⁽³⁾ | | _ | 0.82 | 0.85 | 0.88 | V |
| V _{CCPT} | Power supply for programmable power technology | _ | 1.45 | 1.50 | 1.55 | V |
| V _{CC_AUX} | Auxiliary supply for the programmable power technology | _ | 2.375 | 2.5 | 2.625 | V |
| VI (1) | I/O pre-driver (3.0 V) power supply | _ | 2.85 | 3.0 | 3.15 | V |
| V _{CCPD} ⁽¹⁾ | I/O pre-driver (2.5 V) power supply | _ | 2.375 | 2.5 | 2.625 | V |
| | I/O buffers (3.0 V) power supply | | 2.85 | 3.0 | 3.15 | V |
| | I/O buffers (2.5 V) power supply | _ | 2.375 | 2.5 | 2.625 | V |
| | I/O buffers (1.8 V) power supply | | 1.71 | 1.8 | 1.89 | V |
| V _{CCIO} | I/O buffers (1.5 V) power supply | _ | 1.425 | 1.5 | 1.575 | V |
| | I/O buffers (1.35 V) power supply | _ | 1.283 | 1.35 | 1.45 | V |
| | I/O buffers (1.25 V) power supply | _ | 1.19 | 1.25 | 1.31 | V |
| | I/O buffers (1.2 V) power supply | _ | 1.14 | 1.2 | 1.26 | V |
| | Configuration pins (3.0 V) power supply | _ | 2.85 | 3.0 | 3.15 | V |
| V _{CCPGM} | Configuration pins (2.5 V) power supply | _ | 2.375 | 2.5 | 2.625 | V |
| | Configuration pins (1.8 V) power supply | _ | 1.71 | 1.8 | 1.89 | V |
| V _{CCA_FPLL} | PLL analog voltage regulator power supply | _ | 2.375 | 2.5 | 2.625 | V |
| V _{CCD_FPLL} | PLL digital voltage regulator power supply | _ | 1.45 | 1.5 | 1.55 | V |
| V _{CCBAT} (2) | Battery back-up power supply (For design security volatile key register) | _ | 1.2 | _ | 3.0 | V |
| VI | DC input voltage | _ | -0.5 | _ | 3.6 | V |
| V ₀ | Output voltage | — | 0 | — | V _{CCIO} | V |
| т | Operating junction temperature | Commercial | 0 | — | 85 | °C |
| TJ | Operating junction temperature | Industrial | -40 | _ | 100 | °C |

| Symbol | Description | Devices | Minimum ⁽⁴⁾ | Typical | Maximum ⁽⁴⁾ | Unit |
|-----------------------|--|------------|------------------------|---------|------------------------|------|
| | | | 0.82 | 0.85 | 0.88 | |
| V _{CCR_GXBR} | Receiver analog power supply (right side) | 0V 00 0T | 0.87 | 0.90 | 0.93 | v |
| (2) | Receiver analog power supply (right side) | GX, GS, GT | 0.97 | 1.0 | 1.03 | v |
| | | | 1.03 | 1.05 | 1.07 | |
| V _{CCR_GTBR} | Receiver analog power supply for GT channels (right side) | GT | 1.02 | 1.05 | 1.08 | V |
| | | | 0.82 | 0.85 | 0.88 | |
| V _{CCT_GXBL} | Transmitter analog power supply (left side) | GX, GS, GT | 0.87 | 0.90 | 0.93 | V |
| | Transmitter analog power supply (left side) | | 0.97 | 1.0 | 1.03 | |
| | | | 1.03 | 1.05 | 5 1.07 | |
| | | GX, GS, GT | 0.82 | 0.85 | 0.88 | V |
| V _{CCT_GXBR} | Transmitter analog nower supply (right side) | | 0.87 | 0.90 | 0.93 | |
| (2) | Transmitter analog power supply (right side) | un, us, ui | 0.97 | 1.0 | 1.03 | |
| | | | 1.03 | 1.05 | 1.07 | |
| V _{CCT_GTBR} | Transmitter analog power supply for GT channels (right side) | GT | 1.02 | 1.05 | 1.08 | V |
| V_{CCL_GTBR} | Transmitter clock network power supply | GT | 1.02 | 1.05 | 1.08 | V |
| V _{CCH_GXBL} | Transmitter output buffer power supply (left side) | GX, GS, GT | 1.425 | 1.5 | 1.575 | V |
| V _{CCH_GXBR} | Transmitter output buffer power supply (right side) | GX, GS, GT | 1.425 | 1.5 | 1.575 | V |

| Table 7. | Recommended Transceiver Power Supply Operating Conditions for Stratix V GX, | GS, and GT Devices |
|----------|---|--------------------|
| (Part 2 | of 2) | |

Notes to Table 7:

(1) This supply must be connected to 3.0 V if the CMU PLL, receiver CDR, or both, are configured at a base data rate > 6.5 Gbps. Up to 6.5 Gbps, you can connect this supply to either 3.0 V or 2.5 V.

(2) Refer to Table 8 to select the correct power supply level for your design.

(3) When using ATX PLLs, the supply must be 3.0 V.

(4) This value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

I/O Pin Leakage Current

Table 9 lists the Stratix V I/O pin leakage current specifications.

| Table 9. I/ | 0 Pin Leakage | Current for Stratix | / Devices ⁽¹⁾ |
|-------------|---------------|-----------------------------|--------------------------|
|-------------|---------------|-----------------------------|--------------------------|

| Symbol | Description | Conditions | Min | Тур | Max | Unit |
|-----------------|--------------------|-------------------------------------|-----|-----|-----|------|
| I _I | Input pin | $V_I = 0 V \text{ to } V_{CCIOMAX}$ | -30 | — | 30 | μA |
| I _{0Z} | Tri-stated I/O pin | $V_0 = 0 V$ to $V_{CCIOMAX}$ | -30 | | 30 | μA |

Note to Table 9:

(1) If $V_0 = V_{CCIO}$ to $V_{CCIOMax}$, 100 μ A of leakage current per I/O is expected.

Bus Hold Specifications

Table 10 lists the Stratix V device family bus hold specifications.

Table 10. Bus Hold Parameters for Stratix V Devices

| | | | V _{CCI0} | | | | | | | | | | |
|-------------------------------|-------------------|--|-------------------|------|-------|------|-------|------|-------|------|-------|------|------|
| Parameter | Symbol | Conditions | 1.2 | 2 V | 1. | 5 V | 1.8 | B V | 2. | 5 V | 3.0 | V | Unit |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | Min | Max | |
| Low sustaining current | I _{SUSL} | V _{IN} > V _{IL} (maximum) | 22.5 | _ | 25.0 | _ | 30.0 | _ | 50.0 | _ | 70.0 | _ | μA |
| High sustaining current | I _{SUSH} | V _{IN} < V _{IH} (minimum) | -22.5 | _ | -25.0 | _ | -30.0 | _ | -50.0 | _ | -70.0 | _ | μA |
| Low overdrive current | I _{odl} | $0V < V_{IN} < V_{CCIO}$ | _ | 120 | _ | 160 | _ | 200 | _ | 300 | _ | 500 | μA |
| High overdrive current | I _{odh} | 0V < V _{IN} < V _{CCI0} | | -120 | | -160 | _ | -200 | | -300 | _ | -500 | μA |
| Bus-hold trip point | V _{trip} | _ | 0.45 | 0.95 | 0.50 | 1.00 | 0.68 | 1.07 | 0.70 | 1.70 | 0.80 | 2.00 | V |

On-Chip Termination (OCT) Specifications

If you enable OCT calibration, calibration is automatically performed at power-up for I/Os connected to the calibration block. Table 11 lists the Stratix V OCT termination calibration accuracy specifications.

Table 11. OCT Calibration Accuracy Specifications for Stratix V Devices ⁽¹⁾ (Part 1 of 2)

| Symbol | | | Calibration Accuracy | | | | |
|---------------------|---|--|----------------------|-------|----------------|-------|------|
| | Description | Conditions | C1 | C2,12 | C3,I3, I3YY | C4,14 | Unit |
| 25-Ω R _S | Internal series termination with calibration (25- Ω setting) | V _{CCI0} = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15 | ±15 | ±15 | ±15 | % |

| Symbol | Description | V _{CCIO} (V) | Typical | Unit |
|--------|--|-----------------------|---------|------|
| | | 3.0 | 0.189 | |
| | | 2.5 | 0.208 | |
| dR/dT | OCT variation with temperature without recalibration | 1.8 | 0.266 | %/°C |
| | without robalibration | 1.5 | 0.273 | |
| | | 1.2 | 0.317 | |

Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 2 of 2)⁽¹⁾

Note to Table 13:

(1) Valid for a V_{CCIO} range of $\pm 5\%$ and a temperature range of 0° to 85°C.

Pin Capacitance

Table 14 lists the Stratix V device family pin capacitance.

Table 14. Pin Capacitance for Stratix V Devices

| Symbol | Value | Unit | | | | |
|--------------------|--|------|----|--|--|--|
| C _{IOTB} | Input capacitance on the top and bottom I/O pins | 6 | pF | | | |
| C _{IOLR} | P _{IOLR} Input capacitance on the left and right I/O pins | | | | | |
| C _{OUTFB} | Input capacitance on dual-purpose clock output and feedback pins | 6 | рF | | | |

Hot Socketing

Table 15 lists the hot socketing specifications for Stratix V devices.

| Table 15. | Hot Socketing Specifications for Stratix V Devices |
|-----------|--|
|-----------|--|

| Symbol | Description | Maximum |
|---------------------------|--|---------------------|
| I _{IOPIN (DC)} | DC current per I/O pin | 300 μA |
| I _{IOPIN (AC)} | AC current per I/O pin | 8 mA ⁽¹⁾ |
| I _{XCVR-TX (DC)} | DC current per transceiver transmitter pin | 100 mA |
| I _{XCVR-RX (DC)} | DC current per transceiver receiver pin | 50 mA |

Note to Table 15:

(1) The I/O ramp rate is 10 ns or more. For ramp rates faster than 10 ns, $|I_{10PIN}| = C dv/dt$, in which C is the I/O pin capacitance and dv/dt is the slew rate.

| Symbol/ | Conditions | Trai | nsceive Grade | r Speed 1 | Trai | nsceive Grade | r Speed 2 | Trai | nsceive Grade | r Speed 3 | Unit |
|--|--|--|------------------|--------------|-----------------------|------------------|--------------------|------|------------------|--------------------|-------------|
| Description | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | |
| Spread-spectrum downspread | PCle | _ | 0 to 0.5 | _ | _ | 0 to 0.5 | | _ | 0 to 0.5 | _ | % |
| On-chip termination resistors ⁽²¹⁾ | _ | _ | 100 | | _ | 100 | | _ | 100 | | Ω |
| Absolute V _{MAX} ⁽⁵⁾ | Dedicated reference clock pin | _ | _ | 1.6 | _ | _ | 1.6 | _ | _ | 1.6 | V |
| | RX reference clock pin | _ | _ | 1.2 | _ | | 1.2 | | _ | 1.2 | |
| Absolute V_{MIN} | — | -0.4 | — | | -0.4 | — | — | -0.4 | — | — | V |
| Peak-to-peak differential input voltage | _ | 200 | _ | 1600 | 200 | _ | 1600 | 200 | _ | 1600 | mV |
| V _{ICM} (AC | Dedicated reference clock pin | 1050/1000/900/850 ⁽²⁾ 1050/1000/900/850 ⁽²⁾ 1050/1000/ | | 1000/90 | 00/850 ⁽²⁾ | mV | | | | | |
| coupled) ⁽³⁾ | RX reference clock pin | 1.0/0.9/0.85 ⁽⁴⁾ | | | 1. | 0/0.9/0 | .85 ⁽⁴⁾ | 1. | 0/0.9/0 | .85 ⁽⁴⁾ | V |
| V _{ICM} (DC coupled) | HCSL I/O standard for PCIe reference clock | 250 | | 550 | 250 | | 550 | 250 | | 550 | mV |
| | 100 Hz | — | — | -70 | — | — | -70 | — | — | -70 | dBc/Hz |
| Transmitter | 1 kHz | | | -90 | | | -90 | | — | -90 | dBc/Hz |
| REFCLK Phase Noise | 10 kHz | — | — | -100 | — | — | -100 | — | — | -100 | dBc/Hz |
| (622 MHz) ⁽²⁰⁾ | 100 kHz | | | -110 | — | — | -110 | — | — | -110 | dBc/Hz |
| | ≥1 MHz | — | — | -120 | — | — | -120 | — | — | -120 | dBc/Hz |
| Transmitter REFCLK Phase Jitter (100 MHz) ⁽¹⁷⁾ | 10 kHz to 1.5 MHz (PCle) | _ | _ | 3 | _ | _ | 3 | _ | _ | 3 | ps (rms) |
| R _{REF} (19) | _ | | 1800 ±1% | | _ | 1800 ±1% | _ | | 180 0 ±1% | | Ω |
| Transceiver Clocks | S | | | | | | | | | | |
| fixedclk clock frequency | PCIe Receiver Detect | | 100 or 125 | _ | _ | 100 or 125 | _ | _ | 100 or 125 | _ | MHz |

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 2 of 7)

| Symbol/ | Conditions | Trai | nsceive Grade | r Speed 1 | Trai | nsceive Grade | r Speed 2 | Trai | isceive Grade | er Speed e 3 | Unit |
|---|--|------|------------------|--------------|----------|------------------|--------------|---------|------------------|--------------------------|------|
| Description | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | |
| Reconfiguration clock (mgmt_clk_clk) frequency | _ | 100 | _ | 125 | 100 | | 125 | 100 | | 125 | MHz |
| Receiver | | | | | | | | | | | |
| Supported I/O Standards | _ | | | 1.4-V PCM | L, 1.5-V | PCML, | 2.5-V PCM | L, LVPE | CL, and | d LVDS | |
| Data rate (Standard PCS) (9), (23) | _ | 600 | _ | 12200 | 600 | _ | 12200 | 600 | _ | 8500/ 10312.5 (24) | Mbps |
| Data rate (10G PCS) ^{(9),} ⁽²³⁾ | | 600 | _ | 14100 | 600 | _ | 12500 | 600 | _ | 8500/ 10312.5 (24) | Mbps |
| Absolute V_{MAX} for a receiver pin (5) | | _ | _ | 1.2 | — | _ | 1.2 | — | _ | 1.2 | V |
| Absolute V _{MIN} for a receiver pin | _ | -0.4 | _ | | -0.4 | _ | _ | -0.4 | _ | _ | V |
| Maximum peak- to-peak differential input voltage V _{ID} (diff p- p) before device configuration ⁽²²⁾ | _ | _ | _ | 1.6 | _ | _ | 1.6 | _ | _ | 1.6 | V |
| Maximum peak- to-peak | V _{CCR_GXB} = 1.0 V/1.05 V (V _{ICM} = 0.70 V) | _ | _ | 2.0 | _ | _ | 2.0 | _ | _ | 2.0 | V |
| differential input voltage V_{ID} (diff p- p) after device configuration ⁽¹⁸⁾ , | $V_{CCR_GXB} = 0.90 V$ (V _{ICM} = 0.6 V) | _ | _ | 2.4 | _ | _ | 2.4 | _ | _ | 2.4 | V |
| (22) | $V_{CCR_GXB} = 0.85 V$ (V _{ICM} = 0.6 V) | | | 2.4 | | | 2.4 | | | 2.4 | V |
| Minimum differential eye opening at receiver serial input pins ^{(6), (22),} (27) | _ | 85 | | _ | 85 | _ | _ | 85 | _ | _ | mV |

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 3 of 7)

| Symbol/ | Conditions | Tra | nsceive Grade | r Speed 1 | Trai | nsceive Grade | r Speed 2 | Trar | isceive Grade | r Speed 3 | Unit |
|---|--|-----|------------------|--------------|------|------------------|--------------|------|------------------|--------------------------|------|
| Description | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | |
| | DC Gain Setting = 0 | | 0 | _ | _ | 0 | | _ | 0 | — | dB |
| | DC Gain Setting = 1 | _ | 2 | _ | _ | 2 | _ | _ | 2 | _ | dB |
| Programmable DC gain | DC Gain Setting = 2 | _ | 4 | _ | _ | 4 | _ | _ | 4 | _ | dB |
| | DC Gain Setting = 3 | _ | 6 | _ | _ | 6 | _ | _ | 6 | _ | dB |
| | DC Gain Setting = 4 | _ | 8 | _ | _ | 8 | _ | _ | 8 | — | dB |
| Transmitter | | | | | | | | | | | |
| Supported I/O Standards | _ | | | | - | I.4-V ar | nd 1.5-V PC | ML | | | |
| Data rate (Standard PCS) | _ | 600 | _ | 12200 | 600 | _ | 12200 | 600 | _ | 8500/ 10312.5 (24) | Mbps |
| Data rate (10G PCS) | _ | 600 | _ | 14100 | 600 | | 12500 | 600 | | 8500/ 10312.5 (24) | Mbps |
| | 85-Ω setting | | 85 ± 20% | _ | _ | 85 ± 20% | | _ | 85 ± 20% | _ | Ω |
| Differential on- | 100-Ω setting | _ | 100 ± 20% | _ | _ | 100 ± 20% | _ | _ | 100 ± 20% | _ | Ω |
| chip termination resistors | 120-Ω setting | _ | 120 ± 20% | | | 120 ± 20% | | _ | 120 ± 20% | | Ω |
| | 150-Ω setting | | 150 ± 20% | | | 150 ± 20% | | | 150 ± 20% | | Ω |
| V _{OCM} (AC coupled) | 0.65-V setting | | 650 | | _ | 650 | | _ | 650 | _ | mV |
| V _{OCM} (DC coupled) | _ | | 650 | | _ | 650 | | _ | 650 | _ | mV |
| Rise time (7) | 20% to 80% | 30 | | 160 | 30 | | 160 | 30 | | 160 | ps |
| Fall time ⁽⁷⁾ | 80% to 20% | 30 | | 160 | 30 | | 160 | 30 | | 160 | ps |
| Intra-differential pair skew | Tx V _{CM} = 0.5 V and slew rate of 15 ps | | | 15 | | | 15 | | | 15 | ps |
| Intra-transceiver block transmitter channel-to- channel skew | x6 PMA bonded mode | | | 120 | | | 120 | | | 120 | ps |

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 5 of 7)

| Symbol/ Description | Conditions | Trai | Transceiver Speed Grade 1 | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|----------------------------|------------|------|------------------------------|-----|------------------------------|-----|-----|------------------------------|-----|-----|------|
| | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | |
| t _{pll_lock} (16) | _ | | | 10 | | — | 10 | | | 10 | μs |

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 7 of 7)

Notes to Table 23:

(2) The reference clock common mode voltage is equal to the V_{CCR_GXB} power supply level.

(3) This supply must be connected to 1.0 V if the transceiver is configured at a data rate > 6.5 Gbps, and to 1.05 V if configured at a data rate > 10.3 Gbps when DFE is used. For data rates up to 6.5 Gbps, you can connect this supply to 0.85 V.

- (4) This supply follows VCCR_GXB.
- (5) The device cannot tolerate prolonged operation at this absolute maximum.
- (6) The differential eye opening specification at the receiver input pins assumes that **Receiver Equalization** is disabled. If you enable **Receiver Equalization**, the receiver circuitry can tolerate a lower minimum eye opening, depending on the equalization level.
- (7) The Quartus II software automatically selects the appropriate slew rate depending on the configured data rate or functional mode.
- (8) The input reference clock frequency options depend on the data rate and the device speed grade.
- (9) The line data rate may be limited by PCS-FPGA interface speed grade.
- (10) Refer to Figure 1 for the GX channel AC gain curves. The total effective AC gain is the AC gain minus the DC gain.
- (11) t_{LTR} is the time required for the receive CDR to lock to the input reference clock frequency after coming out of reset.
- (12) t_{LTD} is time required for the receiver CDR to start recovering valid data after the rx_is_lockedtodata signal goes high.
- (13) t_{LTD_manual} is the time required for the receiver CDR to start recovering valid data after the rx_is_lockedtodata signal goes high when the CDR is functioning in the manual mode.
- (14) $t_{LTR_LTD_manual}$ is the time the receiver CDR must be kept in lock to reference (LTR) mode after the rx_is_lockedtoref signal goes high when the CDR is functioning in the manual mode.
- (15) $t_{pll_powerdown}$ is the PLL powerdown minimum pulse width.
- (16) t_{pll lock} is the time required for the transmitter CMU/ATX PLL to lock to the input reference clock frequency after coming out of reset.
- (17) To calculate the REFCLK rms phase jitter requirement for PCIe at reference clock frequencies other than 100 MHz, use the following formula: REFCLK rms phase jitter at f(MHz) = REFCLK rms phase jitter at 100 MHz × 100/f.
- (18) The maximum peak to peak differential input voltage V_{ID} after device configuration is equal to 4 × (absolute V_{MAX} for receiver pin V_{ICM}).
- (19) For ES devices, R_{BEF} is 2000 $\Omega \pm 1\%$.
- (20) To calculate the REFCLK phase noise requirement at frequencies other than 622 MHz, use the following formula: REFCLK phase noise at f(MHz) = REFCLK phase noise at 622 MHz + 20*log(f/622).
- (21) SFP/+ optical modules require the host interface to have RD+/- differentially terminated with 100 Ω. The internal OCT feature is available after the Stratix V FPGA configuration is completed. Altera recommends that FPGA configuration is completed before inserting the optical module. Otherwise, minimize unnecessary removal and insertion with unconfigured devices.
- (22) Refer to Figure 2.
- (23) For oversampling designs to support data rates less than the minimum specification, the CDR needs to be in LTR mode only.
- (24) I3YY devices can achieve data rates up to 10.3125 Gbps.
- (25) When you use fPLL as a TXPLL of the transceiver.
- (26) REFCLK performance requires to meet transmitter REFCLK phase noise specification.
- (27) Minimum eye opening of 85 mV is only for the unstressed input eye condition.

⁽¹⁾ Speed grades shown in Table 23 refer to the PMA Speed Grade in the device ordering code. The maximum data rate could be restricted by the Core/PCS speed grade. Contact your Altera Sales Representative for the maximum data rate specifications in each speed grade combination offered. For more information about device ordering codes, refer to the Stratix V Device Overview.

| Mada (2) | Transceiver | PMA Width | 20 | 20 | 16 | 16 | 10 | 10 | 8 | 8 |
|---------------------|----------------------------|--|---------|---------|---------|---------|-----|-----|------|------|
| Mode ⁽²⁾ | Speed Grade PCS/Core Width | | 40 | 20 | 32 | 16 | 20 | 10 | 16 | 8 |
| | 1 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.5 | 5.8 | 5.2 | 4.72 |
| | 2 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.5 | 5.8 | 5.2 | 4.72 |
| | 2 | C3, I3, I3L core speed grade | 9.8 | 9.0 | 7.84 | 7.2 | 5.3 | 4.7 | 4.24 | 3.76 |
| FIFO | | C1, C2, C2L, I2, I2L core speed grade | 8.5 | 8.5 | 8.5 | 8.5 | 6.5 | 5.8 | 5.2 | 4.72 |
| | 3 | I3YY core speed grade | 10.3125 | 10.3125 | 7.84 | 7.2 | 5.3 | 4.7 | 4.24 | 3.76 |
| | 5 | C3, I3, I3L core speed grade | 8.5 | 8.5 | 7.84 | 7.2 | 5.3 | 4.7 | 4.24 | 3.76 |
| | | C4, I4 core speed grade | 8.5 | 8.2 | 7.04 | 6.56 | 4.8 | 4.2 | 3.84 | 3.44 |
| | 1 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.1 | 5.7 | 4.88 | 4.56 |
| | 2 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.1 | 5.7 | 4.88 | 4.56 |
| | 2 | C3, I3, I3L core speed grade | 9.8 | 9.0 | 7.92 | 7.2 | 4.9 | 4.5 | 3.96 | 3.6 |
| Register | | C1, C2, C2L, I2, I2L core speed grade | 10.3125 | 10.3125 | 10.3125 | 10.3125 | 6.1 | 5.7 | 4.88 | 4.56 |
| | 2 | I3YY core speed grade | 10.3125 | 10.3125 | 7.92 | 7.2 | 4.9 | 4.5 | 3.96 | 3.6 |
| | 3 _ | C3, I3, I3L core speed grade | 8.5 | 8.5 | 7.92 | 7.2 | 4.9 | 4.5 | 3.96 | 3.6 |
| | | C4, I4 core speed grade | 8.5 | 8.2 | 7.04 | 6.56 | 4.4 | 4.1 | 3.52 | 3.28 |

Table 25 shows the approximate maximum data rate using the standard PCS.

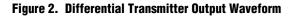
Table 25. Stratix V Standard PCS Approximate Maximum Date Rate (1), (3)

Notes to Table 25:

(1) The maximum data rate is in Gbps.

(2) The Phase Compensation FIFO can be configured in FIFO mode or register mode. In the FIFO mode, the pointers are not fixed, and the latency can vary. In the register mode the pointers are fixed for low latency.

(3) The maximum data rate is also constrained by the transceiver speed grade. Refer to Table 1 for the transceiver speed grade.



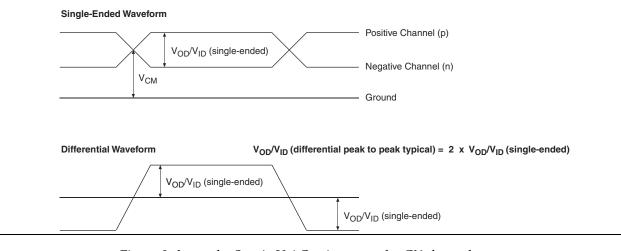


Figure 3 shows the Stratix V AC gain curves for GX channels.

Figure 3. AC Gain Curves for GX Channels (full bandwidth)

Stratix V GT devices contain both GX and GT channels. All transceiver specifications for the GX channels not listed in Table 28 are the same as those listed in Table 23.

Table 28 lists the Stratix V GT transceiver specifications.

| Symbol | Parameter | Min | Тур | Max | Unit |
|---|---|------|---------|--|-----------|
| + (3) (4) | Input clock cycle-to-cycle jitter ($f_{REF} \ge 100 \text{ MHz}$) | _ | — | 0.15 | UI (p-p) |
| t _{INCCJ} ^{(3),} ⁽⁴⁾ | Input clock cycle-to-cycle jitter (f _{REF} < 100 MHz) | -750 | _ | +750 | ps (p-p) |
| t | Period Jitter for dedicated clock output (f_{OUT} \geq 100 MHz) | _ | _ | 175 ⁽¹⁾ | ps (p-p) |
| t _{outpj_dc} ⁽⁵⁾ | Period Jitter for dedicated clock output (f _{OUT} < 100 MHz) | _ | | 17.5 ⁽¹⁾ | mUI (p-p) |
| + (5) | Period Jitter for dedicated clock output in fractional PLL ($f_{0UT} \geq 100 \mbox{ MHz})$ | _ | _ | 250 ⁽¹¹⁾ , 175 ⁽¹²⁾ | ps (p-p) |
| t _{foutpj_dc} ⁽⁵⁾ | Period Jitter for dedicated clock output in fractional PLL (f _{OUT} < 100 MHz) | _ | _ | 25 ⁽¹¹⁾ , 17.5 ⁽¹²⁾ | mUI (p-p) |
| + | Cycle-to-Cycle Jitter for a dedicated clock output ($f_{OUT} \ge 100 \text{ MHz}$) | _ | _ | 175 | ps (p-p) |
| t _{outccj_dc} ⁽⁵⁾ | Cycle-to-Cycle Jitter for a dedicated clock output (f _{0UT} < 100 MHz) | _ | _ | 17.5 | mUI (p-p) |
| + <i>(5)</i> | Cycle-to-cycle Jitter for a dedicated clock output in fractional PLL (f_{OUT} \geq 100 MHz) | _ | _ | 250 ⁽¹¹⁾ , 175 ⁽¹²⁾ | ps (p-p) |
| t _{FOUTCCJ_DC} ⁽⁵⁾ | Cycle-to-cycle Jitter for a dedicated clock output in fractional PLL ($f_{OUT} < 100 \text{ MHz}$)+ | _ | _ | 25 ⁽¹¹⁾ , 17.5 ⁽¹²⁾ | mUI (p-p) |
| t _{outpj_io} (5), | Period Jitter for a clock output on a regular I/O in integer PLL (f_{OUT} \geq 100 MHz) | _ | _ | 600 | ps (p-p) |
| (8) | Period Jitter for a clock output on a regular I/O (f _{OUT} < 100 MHz) | _ | _ | 60 | mUI (p-p) |
| t _{FOUTPJ_IO} (5), | Period Jitter for a clock output on a regular I/O in fractional PLL ($f_{OUT} \ge 100 \text{ MHz}$) | _ | _ | 600 (10) | ps (p-p) |
| (8), (11) | Period Jitter for a clock output on a regular I/O in fractional PLL (f _{OUT} < 100 MHz) | _ | _ | 60 ⁽¹⁰⁾ | mUI (p-p) |
| t _{outccj_io} (5), | Cycle-to-cycle Jitter for a clock output on a regular I/O in integer PLL (f_{OUT} \geq 100 MHz) | _ | _ | 600 | ps (p-p) |
| (8) | Cycle-to-cycle Jitter for a clock output on a regular I/O in integer PLL (f_{OUT} < 100 MHz) | _ | _ | 60 ⁽¹⁰⁾ | mUI (p-p) |
| t _{foutccj_10} ^{(5),} | Cycle-to-cycle Jitter for a clock output on a regular I/O in fractional PLL ($f_{0UT} \geq 100 \mbox{ MHz})$ | _ | _ | 600 ⁽¹⁰⁾ | ps (p-p) |
| (8), (11) | Cycle-to-cycle Jitter for a clock output on a regular I/O in fractional PLL ($f_{OUT} < 100 \text{ MHz}$) | _ | _ | 60 | mUI (p-p) |
| t _{casc_outpj_dc} | Period Jitter for a dedicated clock output in cascaded PLLs (f_{0UT} \geq 100 MHz) | | _ | 175 | ps (p-p) |
| (5), (6) | Period Jitter for a dedicated clock output in cascaded PLLs (f _{OUT} < 100 MHz) | | _ | 17.5 | mUI (p-p) |
| f _{DRIFT} | Frequency drift after PFDENA is disabled for a duration of 100 μs | _ | _ | ±10 | % |
| dK _{BIT} | Bit number of Delta Sigma Modulator (DSM) | 8 | 24 | 32 | Bits |
| k _{value} | Numerator of Fraction | 128 | 8388608 | 2147483648 | |

Table 31. PLL Specifications for Stratix V Devices (Part 2 of 3)

| | | Resour | ces Used | | | Pe | erforman | ce | | | |
|---------------|---|--------|----------|-----|------------|-----|----------|---------|---------------------|-----|------|
| Memory | Mode | ALUTS | Memory | C1 | C2, C2L | C3 | C4 | 12, 12L | 13, 13L, 13YY | 14 | Unit |
| | Single-port, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |
| | Simple dual-port, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |
| | Simple dual-port with the read-during-write option set to Old Data , all supported widths | 0 | 1 | 525 | 525 | 455 | 400 | 525 | 455 | 400 | MHz |
| M20K Block | Simple dual-port with ECC enabled, 512 × 32 | 0 | 1 | 450 | 450 | 400 | 350 | 450 | 400 | 350 | MHz |
| | Simple dual-port with ECC and optional pipeline registers enabled, 512 × 32 | 0 | 1 | 600 | 600 | 500 | 450 | 600 | 500 | 450 | MHz |
| | True dual port, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |
| | ROM, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |

Table 33. Memory Block Performance Specifications for Stratix V Devices ^{(1), (2)} (Part 2 of 2)

Notes to Table 33:

(1) To achieve the maximum memory block performance, use a memory block clock that comes through global clock routing from an on-chip PLL set to **50**% output duty cycle. Use the Quartus II software to report timing for this and other memory block clocking schemes.

(2) When you use the error detection cyclical redundancy check (CRC) feature, there is no degradation in F_{MAX}.

(3) The F_{MAX} specification is only achievable with Fitter options, MLAB Implementation In 16-Bit Deep Mode enabled.

Temperature Sensing Diode Specifications

Table 34 lists the internal TSD specification.

Table 34. Internal Temperature Sensing Diode Specification

| Temperature Range | Accuracy | Offset Calibrated Option | Sampling Rate | Conversion Time | Resolution | Minimum Resolution with no Missing Codes |
|----------------------|----------|--------------------------------|----------------|--------------------|------------|---|
| –40°C to 100°C | ±8°C | No | 1 MHz, 500 KHz | < 100 ms | 8 bits | 8 bits |

Table 35 lists the specifications for the Stratix V external temperature sensing diode.

| Description | Min | Тур | Max | Unit |
|--|-------|-------|-------|------|
| I _{bias} , diode source current | 8 | — | 200 | μA |
| V _{bias,} voltage across diode | 0.3 | — | 0.9 | V |
| Series resistance | | — | < 1 | Ω |
| Diode ideality factor | 1.006 | 1.008 | 1.010 | |

| 0h.a.l | Oanditiana | | C1 | | C2, | C2L, I | 2, I2L | C3, | 13, 131 | ., I 3YY | | C4,14 | | 11 |
|---|--|-----|-----|------|-----|--------|--------|-----|---------|-----------------|-----|-------|------|------|
| Symbol | Conditions | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| Transmitter | • | | | | | | | | | | | | | • |
| | SERDES factor J = 3 to 10 (9), (11), (12), (13), (14), (15), (16) | (6) | _ | 1600 | (6) | _ | 1434 | (6) | _ | 1250 | (6) | _ | 1050 | Mbps |
| True Differential I/O Standards | $\begin{array}{c} \text{SERDES factor J} \\ \geq 4 \end{array}$ | | | | | | | | | | | | | |
| | LVDS TX with DPA ⁽¹²⁾ , ⁽¹⁴⁾ , ⁽¹⁵⁾ , ⁽¹⁶⁾ | (6) | | 1600 | (6) | | 1600 | (6) | _ | 1600 | (6) | _ | 1250 | Mbps |
| - f _{HSDR} (data rate) | SERDES factor J = 2, | (6) | | (7) | (6) | | (7) | (6) | | (7) | (6) | | (7) | Mbps |
| | uses DDR Registers | (0) | _ | (7) | (0) | | (7) | (0) | _ | (7) | (0) | _ | (7) | wups |
| | SERDES factor J = 1, uses SDR Register | (6) | _ | (7) | (6) | _ | (7) | (6) | | (7) | (6) | | (7) | Mbps |
| Emulated Differential I/O Standards with Three External Output Resistor Networks - f _{HSDR} (data rate) ⁽¹⁰⁾ | SERDES factor J = 4 to 10 (17) | (6) | | 1100 | (6) | | 1100 | (6) | | 840 | (6) | | 840 | Mbps |
| t _{x Jitter} - True Differential | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | _ | _ | 160 | _ | _ | 160 | | | 160 | _ | | 160 | ps |
| I/O Standards | Total Jitter for Data Rate < 600 Mbps | _ | _ | 0.1 | _ | _ | 0.1 | _ | _ | 0.1 | _ | _ | 0.1 | UI |
| t _{x Jitter} - Emulated Differential I/O Standards | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | _ | _ | 300 | _ | _ | 300 | _ | _ | 300 | _ | _ | 325 | ps |
| with Three External Output Resistor Network | Total Jitter for Data Rate < 600 Mbps | _ | | 0.2 | | | 0.2 | | | 0.2 | _ | | 0.25 | UI |

Table 36. High-Speed I/O Specifications for Stratix V Devices (1), (2) (Part 2 of 4)

| Symbol | Description | Min | Max | Unit |
|-------------------|--|-----|---------------------------|------|
| t _{JPH} | JTAG port hold time | 5 | — | ns |
| t _{JPCO} | JTAG port clock to output | — | 11 ⁽¹⁾ | ns |
| t _{JPZX} | JTAG port high impedance to valid output | — | 14 ⁽¹⁾ | ns |
| t _{JPXZ} | JTAG port valid output to high impedance | — | 1 4 ⁽¹⁾ | ns |

Table 46. JTAG Timing Parameters and Values for Stratix V Devices

Notes to Table 46:

(1) A 1 ns adder is required for each V_{CCI0} voltage step down from 3.0 V. For example, $t_{JPC0} = 12$ ns if V_{CCI0} of the TDO I/O bank = 2.5 V, or 13 ns if it equals 1.8 V.

(2) The minimum TCK clock period is 167 ns if VCCBAT is within the range 1.2V-1.5V when you perform the volatile key programming.

Raw Binary File Size

For the POR delay specification, refer to the "POR Delay Specification" section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices".

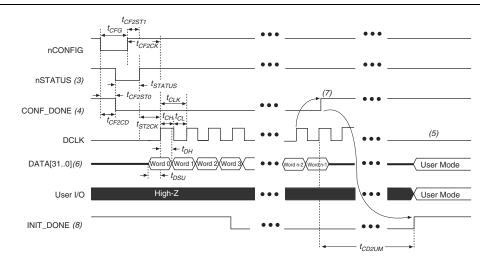
Table 47 lists the uncompressed raw binary file (.rbf) sizes for Stratix V devices.

| Family | Device | Package | Configuration .rbf Size (bits) | IOCSR .rbf Size (bits) ^{(4), (5)} | |
|--------------|--------|------------------------------|--------------------------------|--|--|
| | ECCVA2 | H35, F40, F35 ⁽²⁾ | 213,798,880 | 562,392 | |
| | 5SGXA3 | H29, F35 ⁽³⁾ | 137,598,880 | 564,504 | |
| | 5SGXA4 | _ | 213,798,880 | 563,672 | |
| | 5SGXA5 | _ | 269,979,008 | 562,392 | |
| | 5SGXA7 | _ | 269,979,008 | 562,392 | |
| Stratix V GX | 5SGXA9 | _ | 342,742,976 | 700,888 | |
| | 5SGXAB | _ | 342,742,976 | 700,888 | |
| | 5SGXB5 | _ | 270,528,640 | 584,344 | |
| | 5SGXB6 | _ | 270,528,640 | 584,344 | |
| | 5SGXB9 | _ | 342,742,976 | 700,888 | |
| | 5SGXBB | _ | 342,742,976 | 700,888 | |
| Stratix V GT | 5SGTC5 | _ | 269,979,008 | 562,392 | |
| | 5SGTC7 | — | 269,979,008 | 562,392 | |
| | 5SGSD3 | _ | 137,598,880 | 564,504 | |
| | 5SGSD4 | F1517 | 213,798,880 | 563,672 | |
| Ctratic V CC | 556504 | _ | 137,598,880 | 564,504 | |
| Stratix V GS | 5SGSD5 | _ | 213,798,880 | 563,672 | |
| | 5SGSD6 | _ | 293,441,888 | 565,528 | |
| | 5SGSD8 | _ | 293,441,888 | 565,528 | |

Table 47. Uncompressed .rbf Sizes for Stratix V Devices

FPP Configuration Timing when DCLK-to-DATA [] = 1

Figure 12 shows the timing waveform for FPP configuration when using a MAX II or MAX V device as an external host. This waveform shows timing when the DCLK-to-DATA[] ratio is 1.





Notes to Figure 12:

- (1) Use this timing waveform when the DCLK-to-DATA [] ratio is 1.
- (2) The beginning of this waveform shows the device in user mode. In user mode, nCONFIG, nSTATUS, and CONF_DONE are at logic-high levels. When nCONFIG is pulled low, a reconfiguration cycle begins.
- (3) After power-up, the Stratix V device holds nstatus low for the time of the POR delay.
- (4) After power-up, before and during configuration, CONF_DONE is low.
- (5) Do not leave DCLK floating after configuration. DCLK is ignored after configuration is complete. It can toggle high or low if required.
- (6) For FPP ×16, use DATA [15..0]. For FPP ×8, use DATA [7..0]. DATA [31..0] are available as a user I/O pin after configuration. The state of this pin depends on the dual-purpose pin settings.
- (7) To ensure a successful configuration, send the entire configuration data to the Stratix V device. CONF_DONE is released high when the Stratix V device receives all the configuration data successfully. After CONF_DONE goes high, send two additional falling edges on DCLK to begin initialization and enter user mode.
- (8) After the option bit to enable the INIT_DONE pin is configured into the device, the INIT DONE goes low.

Table 54 lists the PS configuration timing parameters for Stratix V devices.

Table 54. PS Timing Parameters for Stratix V Devices

| Symbol | Parameter | Minimum | Maximum | Units |
|-----------------------------------|---|---|----------------------|-------|
| t _{CF2CD} | nCONFIG low to CONF_DONE low | — | 600 | ns |
| t _{CF2ST0} | nCONFIG low to nSTATUS low | — | 600 | ns |
| t _{CFG} | nCONFIG low pulse width | 2 | — | μS |
| t _{status} | nSTATUS low pulse width | 268 | 1,506 ⁽¹⁾ | μS |
| t _{CF2ST1} | nCONFIG high to nSTATUS high | — | 1,506 ⁽²⁾ | μS |
| t _{CF2CK} (5) | nCONFIG high to first rising edge on DCLK | 1,506 | — | μS |
| t _{ST2CK} ⁽⁵⁾ | nSTATUS high to first rising edge of DCLK | 2 | — | μS |
| t _{DSU} | DATA[] setup time before rising edge on DCLK | 5.5 | — | ns |
| t _{DH} | DATA[] hold time after rising edge on DCLK | 0 | — | ns |
| t _{CH} | DCLK high time | $0.45\times 1/f_{MAX}$ | — | S |
| t _{CL} | DCLK low time | $0.45\times 1/f_{MAX}$ | — | S |
| t _{CLK} | DCLK period | 1/f _{MAX} | — | S |
| f _{MAX} | DCLK frequency | — | 125 | MHz |
| t _{CD2UM} | CONF_DONE high to user mode (3) | 175 | 437 | μS |
| t _{CD2CU} | CONF_DONE high to CLKUSR enabled | 4 × maximum DCLK period | _ | _ |
| t _{CD2UMC} | CONF_DONE high to user mode with CLKUSR option on | t_{CD2CU} + (8576 × CLKUSR period) ⁽⁴⁾ | _ | _ |

Notes to Table 54:

(1) This value is applicable if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.

(2) This value is applicable if you do not delay configuration by externally holding the nSTATUS low.

(3) The minimum and maximum numbers apply only if you choose the internal oscillator as the clock source for initializing the device.

(4) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the "Initialization" section.

(5) If nSTATUS is monitored, follow the t_{ST2CK} specification. If nSTATUS is not monitored, follow the t_{CF2CK} specification.

Initialization

Table 55 lists the initialization clock source option, the applicable configuration schemes, and the maximum frequency.

| Table 55. Initialization Clock Source Option and the Maximu | m Frequency |
|---|-------------|
|---|-------------|

| Initialization Clock Source | Configuration Schemes | Maximum Frequency | Minimum Number of Clock Cycles ⁽¹⁾ |
|--------------------------------|----------------------------|----------------------|--|
| Internal Oscillator | AS, PS, FPP | 12.5 MHz | |
| CLKUSR | AS, PS, FPP ⁽²⁾ | 125 MHz | 8576 |
| DCLK | PS, FPP | 125 MHz | |

Notes to Table 55:

(1) The minimum number of clock cycles required for device initialization.

(2) To enable CLKUSR as the initialization clock source, turn on the Enable user-supplied start-up clock (CLKUSR) option in the Quartus II software from the General panel of the Device and Pin Options dialog box.

Remote System Upgrades

Table 56 lists the timing parameter specifications for the remote system upgrade circuitry.

| Table 56. Remote System Upgrade Circuitry Timing Specifications | Table 56. | Remote System | Upgrade Circuitry | y Timing S | Specifications |
|---|-----------|----------------------|-------------------|------------|-----------------------|
|---|-----------|----------------------|-------------------|------------|-----------------------|

| Parameter | Minimum | Maximum | Unit |
|---|---------|---------|------|
| t _{RU_nCONFIG} ⁽¹⁾ | 250 | — | ns |
| t _{RU_nRSTIMER} ⁽²⁾ | 250 | — | ns |

Notes to Table 56:

- (1) This is equivalent to strobing the reconfiguration input of the ALTREMOTE_UPDATE megafunction high for the minimum timing specification. For more information, refer to the Remote System Upgrade State Machine section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.
- (2) This is equivalent to strobing the reset_timer input of the ALTREMOTE_UPDATE megafunction high for the minimum timing specification. For more information, refer to the User Watchdog Timer section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.

User Watchdog Internal Circuitry Timing Specification

Table 57 lists the operating range of the 12.5-MHz internal oscillator.

Table 57. 12.5-MHz Internal Oscillator Specifications

| Minimum | Typical | Maximum | Units |
|---------|---------|---------|-------|
| 5.3 | 7.9 | 12.5 | MHz |

I/O Timing

Altera offers two ways to determine I/O timing—the Excel-based I/O Timing and the Quartus II Timing Analyzer.

Excel-based I/O timing provides pin timing performance for each device density and speed grade. The data is typically used prior to designing the FPGA to get an estimate of the timing budget as part of the link timing analysis. The Quartus II Timing Analyzer provides a more accurate and precise I/O timing data based on the specifics of the design after you complete place-and-route.

 You can download the Excel-based I/O Timing spreadsheet from the Stratix V Devices Documentation web page.

Programmable IOE Delay

Table 58 lists the Stratix V IOE programmable delay settings.

Table 58. IOE Programmable Delay for Stratix V Devices (Part 1 of 2)

| Parameter Available Min | | Fast | Fast Model | | Slow Model | | | | | | | |
|-------------------------|----------|---------------|------------|------------|------------|-------|-------|-------|-------|-------------|-------|------|
| (1) | Settings | Offset (2) | Industrial | Commercial | C1 | C2 | C3 | C4 | 12 | 13, 13YY | 14 | Unit |
| D1 | 64 | 0 | 0.464 | 0.493 | 0.838 | 0.838 | 0.924 | 1.011 | 0.844 | 0.921 | 1.006 | ns |
| D2 | 32 | 0 | 0.230 | 0.244 | 0.415 | 0.415 | 0.459 | 0.503 | 0.417 | 0.456 | 0.500 | ns |

| Letter | Subject | Definitions |
|--------|----------------------|--|
| V | V _{CM(DC)} | DC common mode input voltage. |
| | V _{ICM} | Input common mode voltage—The common mode of the differential signal at the receiver. |
| | V _{ID} | Input differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the receiver. |
| | V _{DIF(AC)} | AC differential input voltage—Minimum AC input differential voltage required for switching. |
| | V _{DIF(DC)} | DC differential input voltage— Minimum DC input differential voltage required for switching. |
| | V _{IH} | Voltage input high—The minimum positive voltage applied to the input which is accepted by the device as a logic high. |
| | V _{IH(AC)} | High-level AC input voltage |
| | V _{IH(DC)} | High-level DC input voltage |
| | V _{IL} | Voltage input low—The maximum positive voltage applied to the input which is accepted by the device as a logic low. |
| | V _{IL(AC)} | Low-level AC input voltage |
| | V _{IL(DC)} | Low-level DC input voltage |
| | V _{OCM} | Output common mode voltage—The common mode of the differential signal at the transmitter. |
| | V _{OD} | Output differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the transmitter. |
| | V _{SWING} | Differential input voltage |
| | V _X | Input differential cross point voltage |
| | V _{OX} | Output differential cross point voltage |
| W | W | High-speed I/O block—clock boost factor |
| X | | |
| Y | _ | _ |
| Z | | |

Table 60. Glossary (Part 4 of 4)